

QUAD FLAT NO-LEAD (QFN) GRID ARRAY PACKAGE,
METHOD OF MAKING AND MEMORY MODULE AND
COMPUTER SYSTEM INCLUDING SAME

Inventors: Setho Sing Fee et al.

Filed: December 5, 2003

Attorney Docket No. 4738.2US

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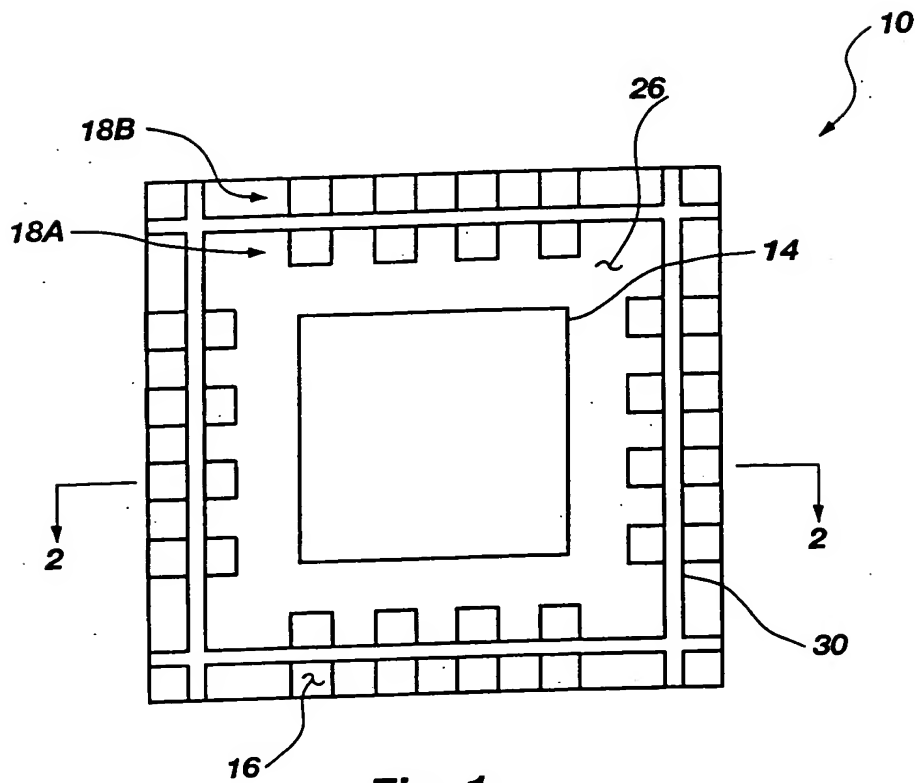


Fig. 1

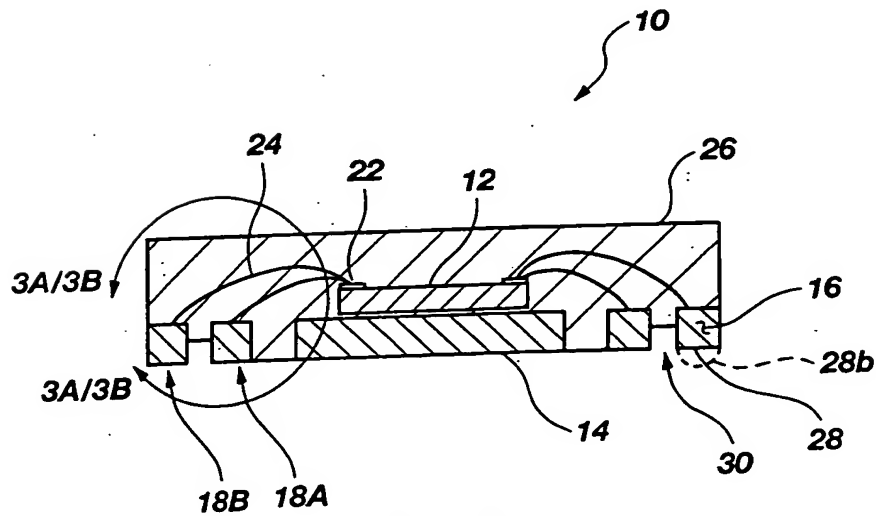


Fig. 2

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Fig. 3B

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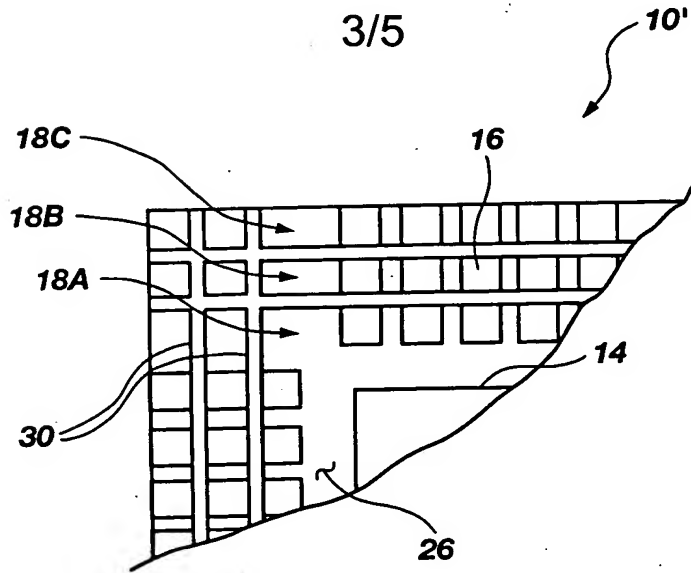


Fig. 4A

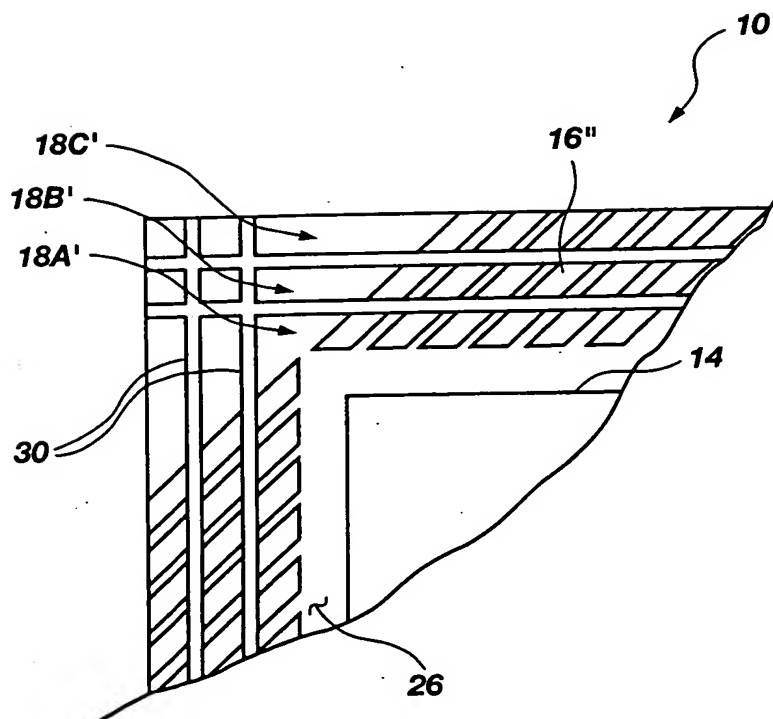


Fig. 4B

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Filed: December 5, 2003

Filed: December 9, 2009
Attorney Docket No. 4738.2US



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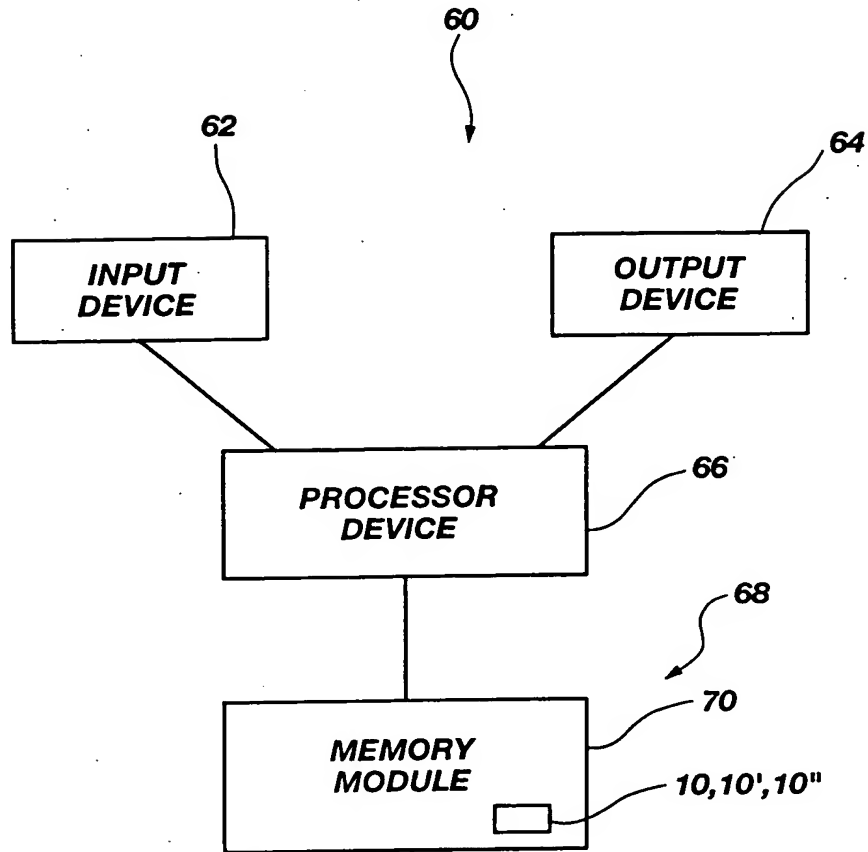


Fig. 6